Features

- EE Reprogrammable 2,097,152 x 1-bit Serial Memories Designed to Store Configuration Programs for Field Programmable Gate Arrays (FPGAs)
- In-System Programmable via 2-wire Bus
- Simple Interface to SRAM FPGAs
- Compatible with Atmel AT6000, AT40K and AT94K Devices, Altera FLEX[®], APEX[™] Devices, Lucent ORCA[®] FPGAs, Xilinx XC3000[™], XC4000[™], XC5200[™], Spartan[®], Virtex[™] FPGAs
- Cascadable Read Back to Support Additional Configurators or Higher-density Arrays
- Low-power CMOS EEPROM Process
- Programmable Reset Polarity
- Available in 6 mm x 6 mm x 1 mm 8-lead LAP (Pin-compatible with 8-lead SOIC/VOIC Packages), 20-lead PLCC, 44-lead PLCC and 44-lead TQFP Packages (Pin-compatible Across Product Family)
- Emulation of Atmel's AT24CXXX Serial EEPROMs
- Available in 3.3V \pm 10% LV and 5V \pm 5% C Versions
- System-friendly READY Pin
- Low-power Standby Mode
- Replacement for AT17C/LV020

Description

The AT17C002 and AT17LV002 (high-density AT17 Series) FPGA Configuration EEPROMs (Configurators) provide an easy-to-use, cost-effective configuration memory for programming Field Programmable Gate Arrays. The AT17 Series is packaged in the popular 8-lead LAP, 20-lead PLCC, 44-lead PLCC and the 44-lead TQFP. The AT17 Series family uses a simple serial-access procedure to configure one or more FPGA devices. The user can select the polarity of the reset function by programming four EEPROM bytes. These devices support a write protection mode and a system-friendly READY pin, which signifies a "good" power level to the FPGA and can be used to ensure reliable system power-up.

The AT17 Series Configurators can be programmed with industry-standard programmers, Atmel's ATDH2200E Programming System and Atmel's ATDH2225 ISP Cable.



FPGA Configuration EEPROM Memory

2-megabit

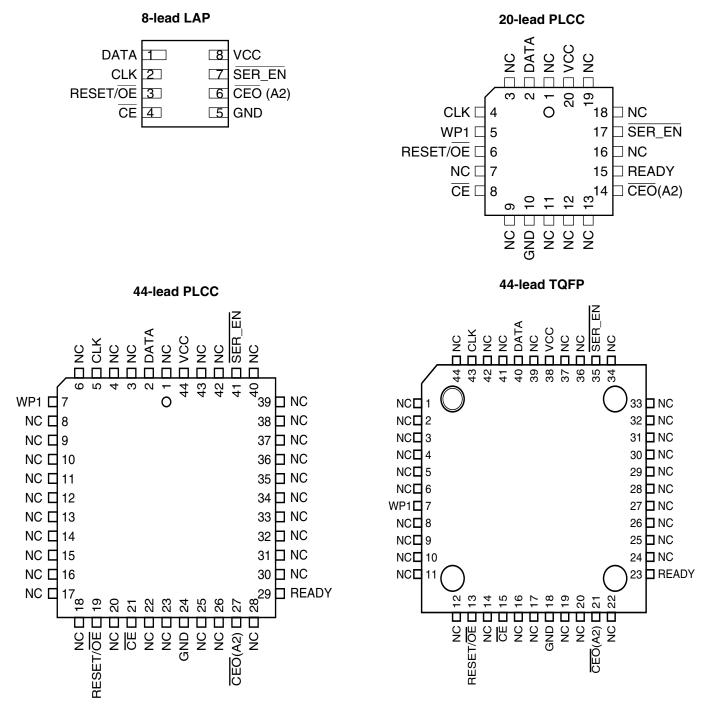
AT17C002 AT17LV002

Rev. 2281D-12/01

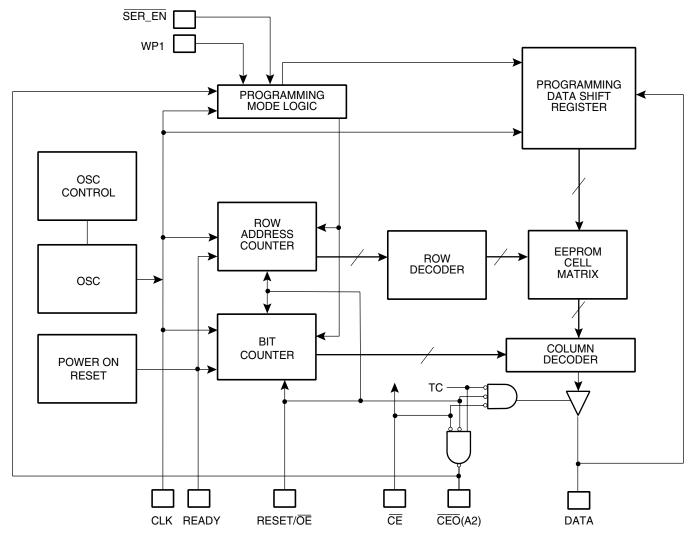




Pin Configuration



Block Diagram



Device Description

The control signals for the configuration EEPROM (\overline{CE} , RESET/ \overline{OE} and CCLK) interface directly with the FPGA device control signals. All FPGA devices can control the entire configuration process and retrieve data from the configuration EEPROM without requiring an external intelligent controller.

The configuration EEPROM RESET/ \overline{OE} and \overline{CE} pins control the tri-state buffer on the DATA output pin and enable the address counter. When RESET/ \overline{OE} is driven High, the configuration EEPROM resets its address counter and tri-states its DATA pin. The \overline{CE} pin also controls the output of the AT17 Series Configurator. If \overline{CE} is held High after the RESET/ \overline{OE} reset pulse, the counter is disabled and the DATA output pin is tri-stated. When \overline{OE} is subsequently driven Low, the counter and the DATA output pin are enabled. When RESET/ \overline{OE} is driven High again, the address counter is reset and the DATA output pin is tri-stated, regardless of the state of \overline{CE} .

When the configurator has driven out all of its data and \overline{CEO} is driven Low, the device tri-states the DATA pin to avoid contention with other configurators. Upon power-up, the address counter is automatically reset.

This is the default setting for the device. Since almost all FPGAs use RESET Low and OE High, this document will describe RESET/OE.





Pin Configurations

| 8 LAP Pin | 20 PLCC Pin | 44 TQFP Pin | 44 PLCC Pin | Name | I/O | Description |
|-----------------|-------------------|-------------------|-------------------|----------------------|-----|---|
| 1 | 2 | 40 | 2 | DATA | I/O | Three-state DATA output for configuration. Open-collector bi-directional pin for programming. |
| 2 | 4 | 43 | 5 | CLK | I | Clock input. Used to increment the internal address and bit counter for reading and programming. |
| _ | 5 | 7 | 7 | WP1 ⁽¹⁾ | Ι | WRITE PROTECT (1). Used to protect portions of memory during programming. Disabled by default due to internal pull-down resistor. This input pin is not used during FPGA loading operations. |
| 3 | 6 | 13 | 19 | RESET/OE | I | Output Enable (active High) and RESET (active Low) when SER_EN is High. A Low level on RESET/OE resets both the address and bit counters. A High level (with CE Low) enables the data output driver. The logic polarity of this input is programmable as either RESET/OE or RESET/OE. For most applications, RESET should be programmed active Low. This document describes the pin as RESET/OE. |
| 4 | 8 | 15 | 21 | CE | I | Chip Enable input (active Low). A Low level (with OE High) allows DCLK to increment the address counter and enables the data output driver. A High level on \overline{CE} disables both the address and bit counters and forces the device into a low-power standby mode. Note that this pin will <i>not</i> enable/disable the device in the 2-wire Serial Programming mode (\overline{SER} _EN Low). |
| 5 | 10 | 18 | 24 | GND | | Ground pin. A 0.2 μF decoupling capacitor between V_{CC} and GND is recommended. |
| 6 | 14 | 21 | 27 | CEO | 0 | Chip Enable Output (active Low). This output goes Low when the address counter has reached its maximum value. In a daisy chain of AT17 Series devices, the CEO pin of one device must be connected to the CE input of the next device in the chain. It will stay Low as long as CE is low and OE is High. It will then follow CE until OE goes Low; thereafter, CEO will stay High until the entire EEPROM is read again. |
| | | | | A2 | I | Device selection input, A2. This is used to enable (or select) the device during programming (i.e., when SER_EN is Low). A2 has an internal pulldown resistor. |
| _ | 15 | 23 | 29 | READY ⁽¹⁾ | 0 | Open collector reset state indicator. Driven Low during power-up reset, released when power-up is complete. (Recommend a 4.7 k Ω pull-up on this pin if used). |
| 7 | 17 | 35 | 41 | SER_EN | I | Serial enable must be held High during FPGA loading operations. Bringing SER_EN Low enables the 2-wire Serial Programming Mode. For non-ISP applications, SER_EN should be tied to V_{CC} . |
| 8 | 20 | 38 | 44 | V _{CC} | | +3.3V/+5V power supply pin. |

Note: 1. This pin is not available on the 8-lead packages.

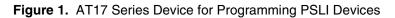
AT17C/LV002

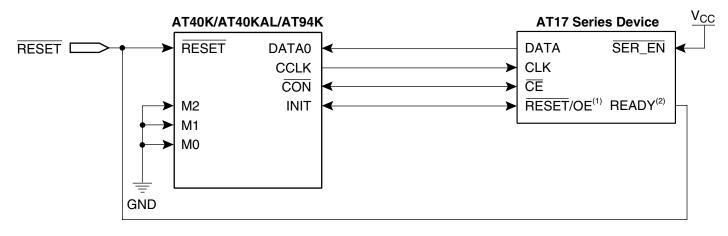
| FPGA Master Serial Mode Summary | The I/O and logic functions of any SRAM-based FPGA are established by a configura- tion program. The program is loaded either automatically upon power-up, or o command, depending on the state of the FPGA mode pins. In Master Mode, the FPGA automatically loads the configuration program from an external memory. The AT1 Serial Configuration EEPROM has been designed for compatibility with the Master Serial Mode. | | | |
|--|---|--|--|--|
| | This document discusses the AT40K, AT40KAL and AT94KAL applications, as well as Xilinx applications. | | | |
| Control of Configuration | Most connections between the FPGA device and the AT17 Serial EEPROM are simple and self-explanatory: The DATA output of the AT17 Series Configurator drives DIN of the FPGA devices. The master FPGA CCLK output drives the CLK input of the AT17 Series Configurator. The CEO output of any AT17 Series Configurator drives the CE input of the next Configurator in a cascade chain of EEPROMs. SER_EN must be connected to V_{CC} (except during ISP). The READY pin is available as an open-collector indicator of the device's reset status; it is driven Low while the device is in its power-on reset cycle and released (tri-stated) when the cycle is complete. | | | |
| Cascading Serial Configuration EEPROMs | For multiple FPGAs configured as a daisy-chain, or for FPGAs requiring larger configu- ration memories, cascaded Configurators provide additional memory. As the last bit from the first Configurator is read, the clock signal to the Configurator asserts its CEO output Low and disables its DATA line driver. The second Configurator recognizes the Low level on its CE input and enables its DATA output. After configuration is complete, the address counters of all cascaded Configurators are reset if the RESET/OE on each Configurator is driven to its active (Low) level. If the address counters are not to be reset upon completion, then the RESET/OE input can be tied to its inactive (High) level. | | | |
| AT17 Series Reset Polarity | The AT17 Series Configurator allows the user to program the reset polarity as either RESET/OE or RESET/OE. This feature is supported by industry-standard programmer algorithms. | | | |
| Programming Mode | The programming mode is entered by bringing $\overline{\text{SER}_{EN}}$ Low. In this mode the chip can be programmed by the 2-wire serial bus. The programming is done at V _{CC} supply only. Programming super voltages are generated inside the chip. The AT17C parts are read/write at 5V nominal. The AT17LV parts are read/write at 3.3V nominal. | | | |
| Standby Mode | The AT17C/LV002 Series Configurator enters a low-power standby mode whenever \overline{CE} is asserted High. In this mode, the Configurator consumes less than 0.5 mA of current at 5V. The output remains in a high-impedance state regardless of the state of the \overline{OE} input. | | | |





Example Circuits

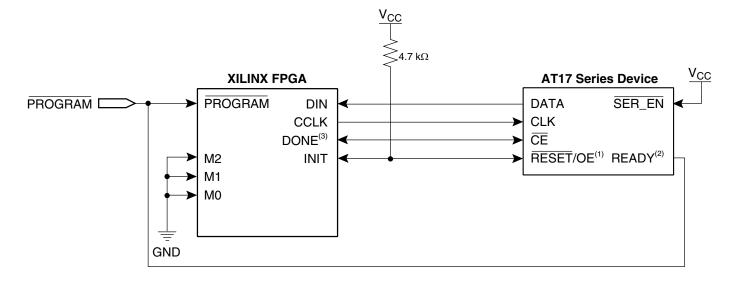




- Notes: 1. Reset polarity must be set to active Low.
 - 2. Use of the optional READY pin is not available on the AT17C/LV65/128/256 devices.

The FPGA CON/DONE output drives the CE input of the AT17 Series Configurator, while the RESET/OE input is driven by the FPGA INIT pin. This connection works under all normal circumstances, even when the user aborts the configuration before CON/DONE has gone High. A Low level on the RESET/OE input, during FPGA reset, clears the configurator's internal address pointer so that the reconfiguration starts at the beginning.

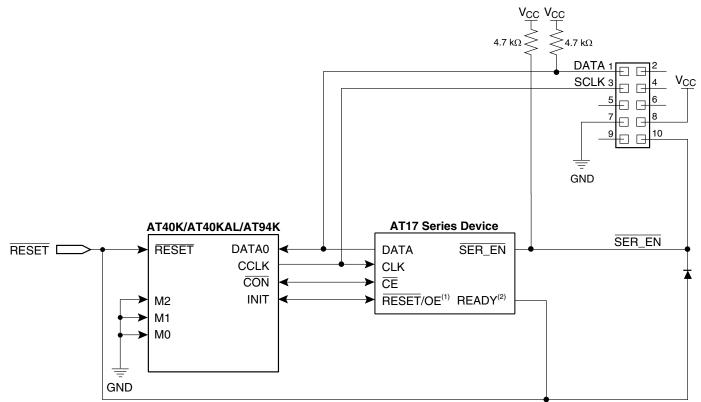
Figure 2. Drop-In Replacement of XC17/ATT17 PROMs for Xilinx/Lucent FPGA Applications



- Notes: 1. Reset polarity must be set to active Low.
 - 2. Use of the optional READY pin is not available on the AT17C/LV65/128/256 devices.
 - 3. An internal pull-up resistor is enabled here for DONE.

For details of ISP, please refer to the "Programming Specification for Atmel's AT17 and AT17A Series FPGA Configuration EEPROMs", available on the Atmel web site, at http://www.atmel.com/atmel/acrobat/doc0437.pdf.

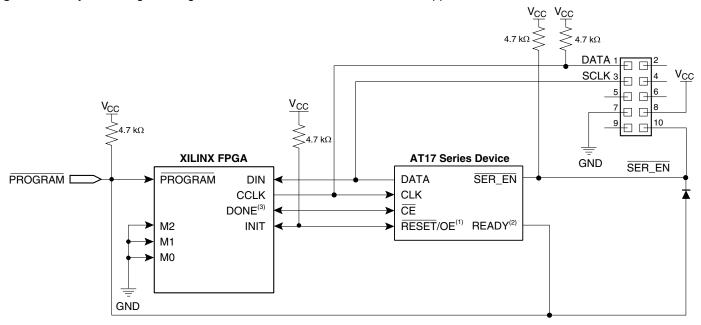
Figure 3. In-System Programming of AT17 Series for PSLI Applications



Notes: 1. Reset polarity must be set to active Low.

2. Use of the optional READY pin is not available on the AT17C/LV65/128/256 devices.

Figure 4. In-System Programming of AT17 Series for Xilinx/Lucent FPGA Applications



- Notes: 1. Reset polarity must be set to active Low.
 - 2. Use of the optional READY pin is not available on the AT17C/LV65/128/256 devices.
 - 3. An internal pull-up resistor is enabled here for DONE.





Absolute Maximum Ratings*

| Operating Temperature55°C to +125°C |
|---|
| Storage Temperature65 °C to +150°C |
| Voltage on Any Pin with Respect to Ground0.1V to $\rm V_{\rm CC}$ +0.5V |
| Supply Voltage (V _{CC})0.5V to +7.0V |
| Maximum Soldering Temp. (10 sec. @ 1/16 in.)260°C |
| ESD (R _{ZAP} = 1.5K, C _{ZAP} = 100 pF) |

*NOTICE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those listed under operating conditions is not implied. Exposure to Absolute Maximum Rating conditions for extended periods of time may affect device reliability.

Operating Conditions

| | | | | AT17C002 | | AT17LV002 | |
|-----------------|-------------|--|------|----------|-----|-----------|-------|
| Symbol | Description | | Min | Max | Min | Max | Units |
| | Commercial | Supply voltage relative to GND, -0°C to +70°C | 4.75 | 5.25 | 3.0 | 3.6 | V |
| V _{cc} | Industrial | Supply voltage relative to GND, -40°C to +85°C | 4.5 | 5.5 | 3.0 | 3.6 | V |
| | Military | Supply voltage relative to GND, -55°C to +125°C | 4.5 | 5.5 | 3.0 | 3.6 | V |

DC Characteristics

| Symbol | Description | | | Max | Units |
|-------------------|--|--------------------------|------|-----------------|-------|
| V _{IH} | High-Level Input Voltage | | 2.0 | V _{CC} | V |
| V _{IL} | Low-level input voltage | | 0.0 | 0.8 | V |
| V _{OH} | High-level Output Voltage (I _{OH} = -4 mA) | | 3.86 | | V |
| V _{OL} | Low-level Output Voltage (I _{OL} = +4 mA) | Commercial | | 0.32 | V |
| V _{OH} | High-level Output Voltage (I _{OH} = -4 mA) | la du atrial | 3.76 | | V |
| V _{OL} | Low-level Output Voltage (I _{OL} = +4 mA) | Industrial | | 0.37 | V |
| V _{OH} | High-level Output Voltage (I _{OH} = -4 mA) | | 3.7 | | V |
| V _{OL} | Low-level Output Voltage (I _{OL} = +4 mA) | Military | | 0.4 | V |
| I _{CCA} | Supply Current, Active Mode | | | 10 | mA |
| IL | Input or Output Leakage Current (V _{IN} = V _{CC} or GN | ID) | -10 | 10 | μA |
| | | Commercial | | 0.5 | mA |
| I _{CCS1} | Supply Current, Standby Mode, CMOS | Industrial/Military | | 0.75 | mA |
| I _{CCS2} | Supply Current, Standby Mode, TTL | TL Commercial/Industrial | | 1 | mA |

 V_{CC} = 5V \pm 5% Commercial, 5V \pm 10% Industrial/Military

DC Characteristics

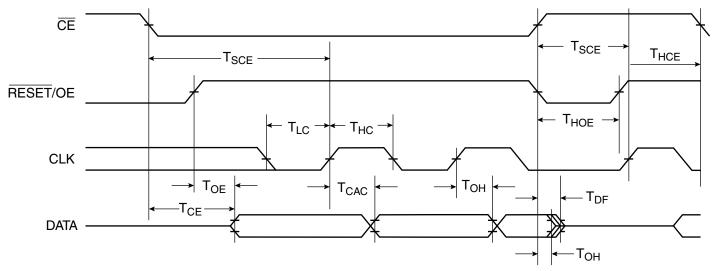
$V_{\rm CC} = 3.3V \pm 10\%$

| Symbol | Description | | | Max | Units |
|------------------|--|---------------------|-----|-----------------|-------|
| V _{IH} | High-level input voltage | | 2.0 | V _{cc} | V |
| V _{IL} | Low-level input voltage | | 0.0 | 0.8 | V |
| V _{OH} | High-level Output Voltage (I _{OH} = -2.5 mA) | O | 2.4 | | V |
| V _{OL} | Low-level Output Voltage (I _{OL} = +3 mA) | Commercial | | 0.4 | V |
| V _{OH} | High-level Output Voltage (I _{OH} = -2 mA) | In ductorial | 2.4 | | V |
| V _{OL} | Low-level Output Voltage (I _{OL} = +3 mA) | Industrial | | 0.4 | V |
| V _{OH} | High-level Output Voltage (I _{OH} = -2 mA) | N 4114 | 2.4 | | V |
| V _{OL} | Low-level Output Voltage (I _{OL} = +2.5 mA) | Military | | 0.4 | V |
| I _{CCA} | Supply Current, Active Mode | | | 5 | mA |
| I _L | Input or Output Leakage Current (V _{IN} = V _{CC} or GND) | | -10 | 10 | μA |
| 1 | Current Charden Made | Commercial | | 200 | μA |
| I _{CCS} | Supply Current, Standby Mode | Industrial/Military | | 200 | μA |

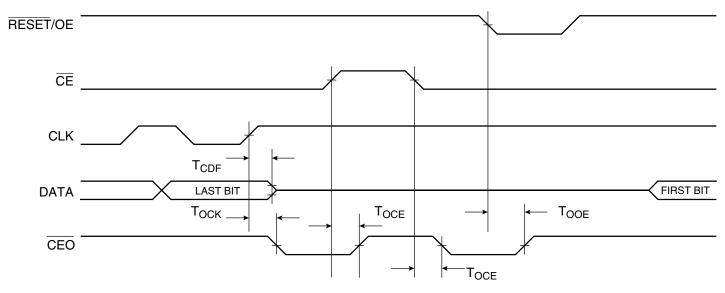




AC Characteristics



AC Characteristics when Cascading



AC Characteristics for AT17C002

| | | Comr | nercial | Industrial/Military ⁽¹⁾ | | |
|--------------------------------|--|------|---------|------------------------------------|-----|-------|
| Symbol | Description | Min | Max | Min | Max | Units |
| T _{OE} ⁽²⁾ | OE to Data Delay | | 30 | | 35 | ns |
| T _{CE} ⁽²⁾ | CE to Data Delay | | 45 | | 45 | ns |
| $T_{CAC}^{(2)}$ | CLK to Data Delay | | 50 | | 50 | ns |
| Т _{он} | Data Hold From \overline{CE} , OE or CLK | 0 | | 0 | | ns |
| T _{DF} ⁽³⁾ | CE or OE to Data Float Delay | | 50 | | 50 | ns |
| T _{LC} | CLK Low Time | 20 | | 20 | | ns |
| T _{HC} | CLK High Time | 20 | | 20 | | ns |
| T _{SCE} | CE Setup Time to CLK (to guarantee proper counting) | 20 | | 25 | | ns |
| T _{HCE} | CE Hold Time from CLK (to guarantee proper counting) | 0 | | 0 | | ns |
| T _{HOE} | OE High Time (guarantees counter is reset) | 20 | | 20 | | ns |
| F _{MAX} | Maximum Input Clock Frequency | 15 | | 15 | | MHz |

 V_{CC} = 5V \pm 5% Commercial, V_{CC} = 5V \pm 10% Industrial/Military

Notes: 1. Preliminary specifications for military operating range only.

2. AC test load = 50 pF.

3. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady state active levels.

AC Characteristics for AT17C002 when Cascading

 $V_{CC} = 5V \pm 5\%$ Commercial/ $V_{CC} = 5V \pm 10\%$ Industrial/Military

| | | Commercial | | Industrial/Military ⁽¹⁾ | | | |
|---------------------------------|-------------------------------|------------|-----|------------------------------------|-----|-------|--|
| Symbol | Description | Min | Мах | Min | Max | Units | |
| T _{CDF} ⁽³⁾ | CLK to Data Float Delay | | 50 | | 50 | ns | |
| T _{OCK} ⁽²⁾ | CLK to CEO Delay | | 35 | | 40 | ns | |
| T _{OCE} ⁽²⁾ | CE to CEO Delay | | 35 | | 35 | ns | |
| T _{OOE} ⁽²⁾ | RESET/OE to CEO Delay | | 30 | | 30 | ns | |
| F _{MAX} | Maximum Input Clock Frequency | 12.5 | | 12.5 | | MHz | |

Notes: 1. Preliminary specifications for military operating range only.

2. AC test load = 50 pF.

3. Float delays are measured with 5 pF AC loads. Transition is measured \pm 200 mV from steady state active levels.





AC Characteristics for AT17LV002

 $V_{CC}=3.3V\pm10\%$

| | | Commercial | | Industrial/Military ⁽¹⁾ | | |
|---------------------------------|--|------------|-----|------------------------------------|-----|-------|
| Symbol | Description | Min | Max | Min | Max | Units |
| T _{OE} ⁽²⁾ | OE to Data Delay | | 50 | | 55 | ns |
| T _{CE} ⁽²⁾ | CE to Data Delay | | 55 | | 60 | ns |
| T _{CAC} ⁽²⁾ | CLK to Data Delay | | 55 | | 60 | ns |
| Т _{ОН} | Data Hold From CE, OE or CLK | 0 | | 0 | | ns |
| $T_{DF}^{(3)}$ | CE or OE to Data Float Delay | | 50 | | 50 | ns |
| T _{LC} | CLK Low Time | 25 | | 25 | | ns |
| T _{HC} | CLK High Time | 25 | | 25 | | ns |
| T _{SCE} | CE Setup Time to CLK (to guarantee proper counting) | 30 | | 35 | | ns |
| T _{HCE} | CE Hold Time from CLK (to guarantee proper counting) | 0 | | 0 | | ns |
| T _{HOE} | OE High Time (guarantees counter is reset) | 25 | | 25 | | ns |
| F _{MAX} | Maximum Input Clock Frequency | 15 | | 10 | | MHz |

Notes: 1. Preliminary specifications for military operating range only.

2. AC test load = 50 pF.

3. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady state active levels.

AC Characteristics for AT17LV002 when Cascading

 $V_{CC} = 3.3V \pm 10\%$

| | | Commercial | | Industrial/Military ⁽¹⁾ | | |
|---------------------------------|-------------------------------|------------|-----|------------------------------------|-----|-------|
| Symbol | Description | Min | Max | Min | Max | Units |
| T _{CDF} ⁽³⁾ | CLK to Data Float Delay | | 50 | | 50 | ns |
| T _{OCK} ⁽²⁾ | CLK to CEO Delay | | 50 | | 55 | ns |
| T _{OCE} ⁽²⁾ | CE to CEO Delay | | 35 | | 40 | ns |
| T _{OOE} ⁽²⁾ | RESET/OE to CEO Delay | | 35 | | 35 | ns |
| F _{MAX} | Maximum Input Clock Frequency | 12.5 | | 10 | | MHz |

Notes: 1. Preliminary specifications for military operating range only.

2. AC test load = 50 pF.

3. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady state active levels.

Thermal Resistance Coefficients⁽¹⁾

| Package Type | | θ _{JC} [° C/W] | θ _{JA} [°C/W] Airflow = 0 ft/min |
|--|------|--------------------------------|--|
| Leadless Array Package (LAP) | 8CN4 | 45 | 159.60 |
| Plastic Leaded Chip Carrier (PLCC) | 20J | 35 | 90 |
| Thin Plastic Quad Flat Package (TQFP) | 44A | 17 | 62 |
| Plastic Leaded Chip Carrier (PLCC) | 44J | 15 | 50 |

Note: 1. For more information refer to the "Thermal Characteristics of Atmel's Packages", available on the Atmel web site, at http://www.atmel.com/atmel/acrobat/doc0636.pdf.





Ordering Information – 5V Devices

| Memory Size | Ordering Code | Package | Operation Range | |
|-------------|--|---------------------------|-------------------------------|--|
| 2-Mbit | AT17C002-10CC AT17C002-10JC AT17C002-10TQC AT17C002-10BJC | 8CN4 20J 44A 44J | Commercial (0°C to 70°C) | |
| | AT17C002-10CI AT17C002-10JI AT17C002-10TQI AT17C002-10BJI | 8CN4 20J 44A 44J | Industrial (-40°C to 85°C) | |

Ordering Information – 3.3V Devices

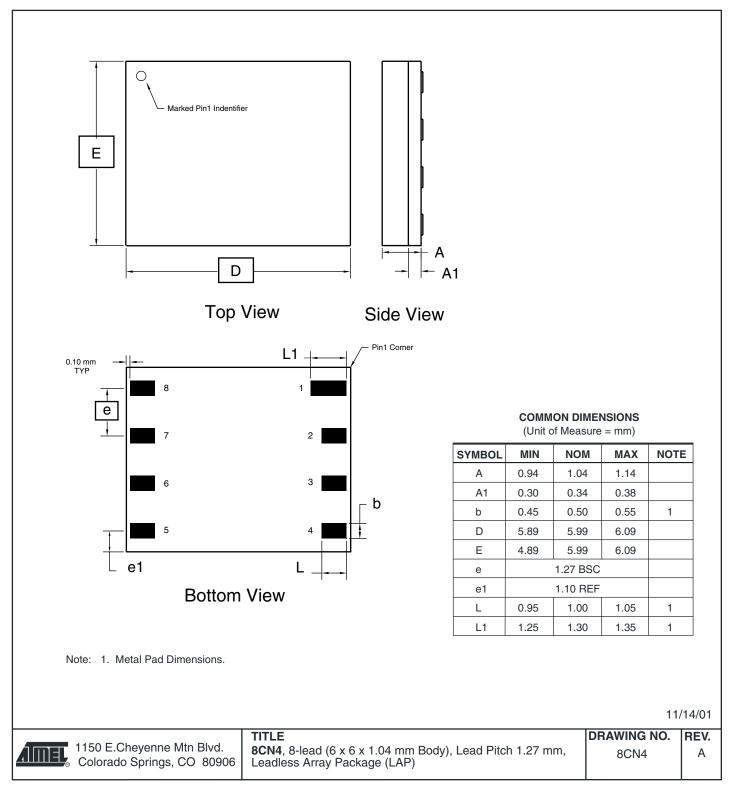
| Memory Size | Ordering Code | Package | Operation Range |
|-------------|--|---------------------------|-------------------------------|
| 2-Mbit | AT17LV002-10CC AT17LV002-10JC AT17LV002-10TQC AT17LV002-10BJC | 8CN4 20J 44A 44J | Commercial (0°C to 70°C) |
| | AT17LV002-10CI AT17LV002-10JI AT17LV002-10TQI AT17LV002-10BJI | 8CN4 20J 44A 44J | Industrial (-40°C to 85°C) |

| Package Type | | |
|--------------|--|--|
| 8CN4 | 8-lead, 6 mm x 6 mm x 1 mm, Leadless Array Package (LAP) – Pin-compatible with 8-lead SOIC/VOIC Packages | |
| 20J | 20-lead, Plastic J-leaded Chip Carrier (PLCC) | |
| 44 A | 44-lead, Thin (1.0 mm) Plastic Quad Flat Package Carrier (TQFP) | |
| 44J | 44-lead, Plastic J-leaded Chip Carrier (PLCC) | |

14 AT17C/LV002

Packaging Information

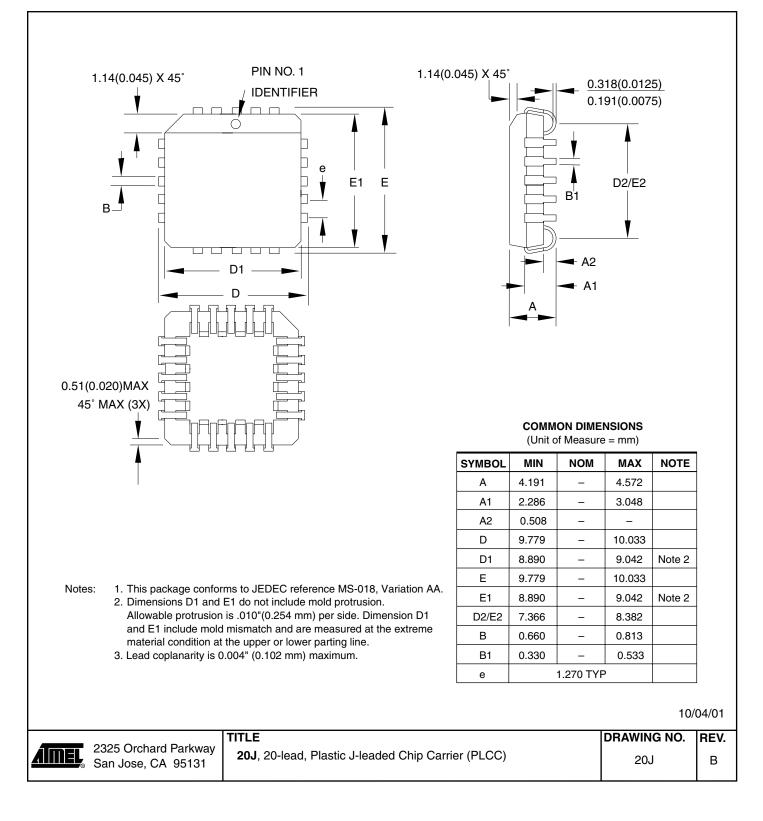
8CN4 – LAP





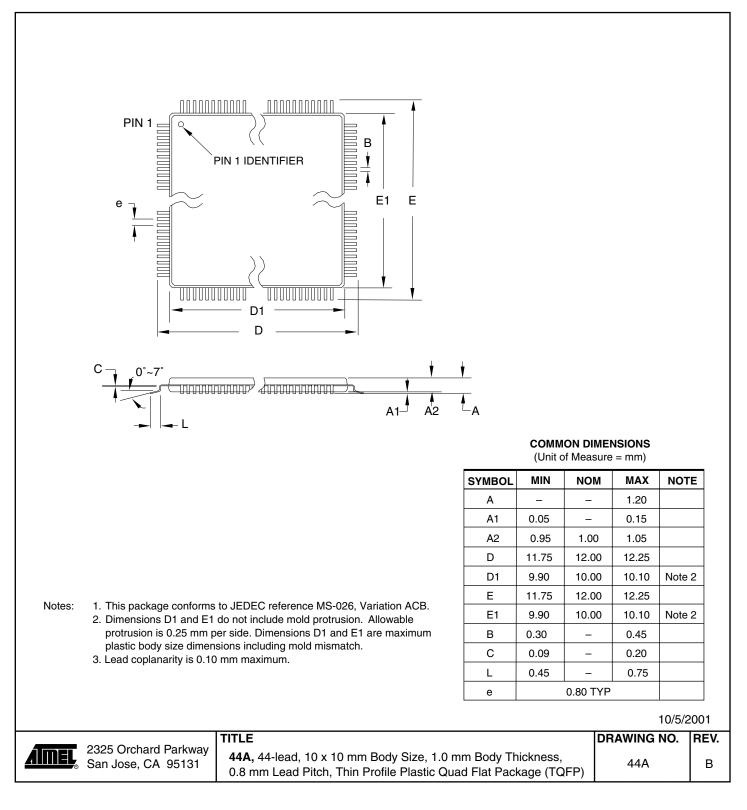


20J – PLCC



AT17C/LV002

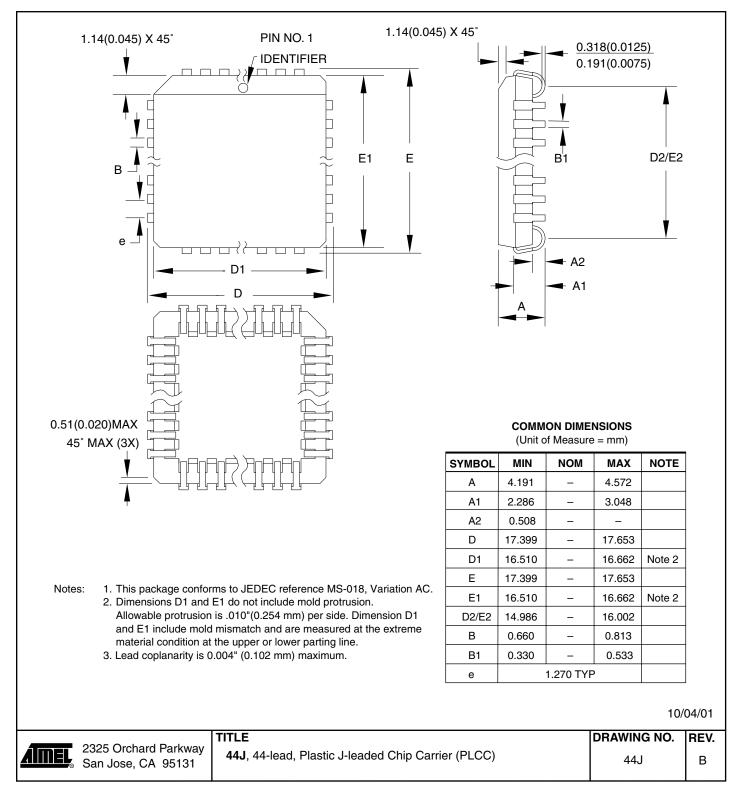
44A – TQFP







44J – PLCC





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FAQ Available on web site

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